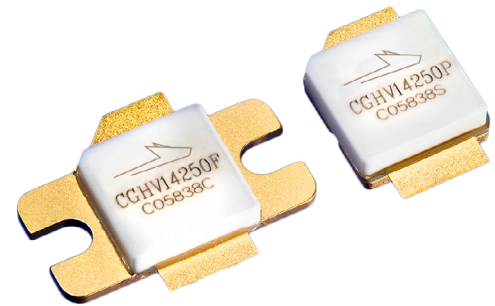


CGHV14250

250 W, DC - 1.6 GHz, GaN HEMT for
L-Band Radar Systems

Description

WolfSpeed's CGHV14250 is a gallium nitride (GaN) high electron mobility transistor (HEMT) designed specifically with high efficiency, high gain and wide bandwidth capabilities, which makes the CGHV14250 ideal for DC - 1.6 GHz L-Band radar amplifier applications. The transistor could be utilized for band specific applications ranging from 0.9 through 1.8 GHz. The package options are ceramic/metal flange and pill package.



Package Types: 440162, 440161
PN: CGHV14250F, CGHV14250P

Typical Performance Over 1.2 - 1.4 GHz ($T_c = 25^\circ\text{C}$) of Demonstration Amplifier

Parameter	1.2 GHz	1.25 GHz	1.3 GHz	1.35 GHz	1.4 GHz	Units
Outdoor Power	365	365	350	310	330	W
Gain	18.6	18.6	18.4	17.9	18.2	dB
Drain Efficiency	80	80	77	74	76	%

Note: Measured in the CGHV14250-AMP amplifier circuit, under 500 μs pulse width, 10% duty cycle, $P_{IN} = 37 \text{ dBm}$.

Features

- Reference design amplifier 1.2 - 1.4 GHz Operation
- FET Tuning range UHF through 1800 MHz
- 330 W Typical Output Power
- 18 dB Power Gain
- 77 % Typical Drain Efficiency
- < 0.3 dB Pulsed Amplitude Droop
- Internally pre-matched on input, unmatched output



Large Signal Models Available for ADS and MWO





Absolute Maximum Ratings (not simultaneous)

Parameter	Symbol	Rating	Units	Conditions
Drain-Source Voltage	V_{DSS}	150	V	25°C
Gate-to-Source Voltage	V_{GS}	-10, +2		
Storage Temperature	T_{STG}	-65, +150	°C	
Operating Junction Temperature	T_J	225		
Maximum Forward Gate Current	I_{GMAX}	42	mA	25°C
Maximum Drain Current ¹	I_{DMAX}	18	A	
Soldering Temperature ²	T_S	245	°C	
Screw Torque	τ	40	in-oz	
CW Thermal Resistance, Junction to Case ³	$R_{\theta JC}$	0.95	°C/W	$P_{DISS} = 167 \text{ W}, 65^\circ\text{C}$
Pulsed Thermal Resistance, Junction to Case ³		0.57		$P_{DISS} = 167 \text{ W}, 500 \mu\text{sec}, 10\%, 85^\circ\text{C}$
Pulsed Thermal Resistance, Junction to Case ⁴		0.63		
Case Operating Temperature ⁵	T_C	-40, +130	°C	$P_{DISS} = 167 \text{ W}, 500 \mu\text{sec}, 10\%$

Notes:

¹ Current limit for long term, reliable operation

² Refer to the Application Note on soldering at wolfspeed.com/rf/document-library

³ Measured for the CGHV14250P

⁴ Measured for the CGHV14250F

⁵ See also, the Power Dissipation De-rating Curve on Page 5

Electrical Characteristics ($T_C = 25^\circ\text{C}$)

Parameter	Symbol	Min.	Typ.	Max.	Units	Conditions
DC Characteristics¹						
Gate Threshold Voltage	$V_{GS(th)}$	-3.8	-3.0	-2.3	V_{DC}	$V_{DS} = 10 \text{ V}, I_D = 41.8 \text{ mA}$
Gate Quiescent Voltage	$V_{GS(Q)}$	—	-2.7	—		$V_{DS} = 50 \text{ V}, I_D = 500 \text{ mA}$
Saturated Drain Current ²	I_{DS}	27.2	38.9	—	A	$V_{DS} = 6.0 \text{ V}, V_{GS} = 2.0 \text{ V}$
Drain-Source Breakdown Voltage	V_{BR}	125	—	—	V_{DC}	$V_{GS} = -8 \text{ V}, I_D = 41.8 \text{ mA}$
RF Characteristics³ ($T_C = 25^\circ\text{C}$, $F_0 = 1.4 \text{ GHz}$ unless otherwise noted)						
Output Power	P_{OUT}	260	300	—	W	$V_{DD} = 50 \text{ V}, I_{DQ} = 500 \text{ mA}, P_{IN} = 37 \text{ dBm}$
Drain Efficiency	D_E	70	77	—	%	
Power Gain	G_P	—	17.8	—	dB	$V_{DD} = 50 \text{ V}, I_{DQ} = 500 \text{ mA}$
Pulsed Amplitude Droop	D	—	-0.3	—		
Output Mismatch Stress	VSWR	—	5 : 1	—	Y	No damage at all phase angles, $V_{DD} = 50 \text{ V}$, $I_{DQ} = 500 \text{ mA}$, $P_{IN} = 37 \text{ dBm}$ Pulsed
Dynamic Characteristics						
Input Capacitance	C_{GS}	—	150	—	pF	$V_{DS} = 50 \text{ V}, V_{GS} = -8 \text{ V}, f = 1 \text{ MHz}$
Output Capacitance	C_{DS}	—	16	—		
Feedback Capacitance	C_{GD}	—	1.35	—		

Notes:

¹ Measured on wafer prior to packaging

² Scaled from PCM data

³ Measured in CGHV14250-AMP. Pulsed Width = 500 μs , Duty Cycle = 10%.



Electrostatic Discharge (ESD) Classifications

Parameter	Symbol	Class	Classification Level	Test Methodology
Human Body Model	HBM	TBD	ANSI/ESDA/JEDEC JS-001 Table 3	JEDEC JESD22 A114-D
Charge Device Model	CDM	TBD	ANSI/ESDA/JEDEC JS-002 Table 3	JEDEC JESD22 C101-C

Typical Performance

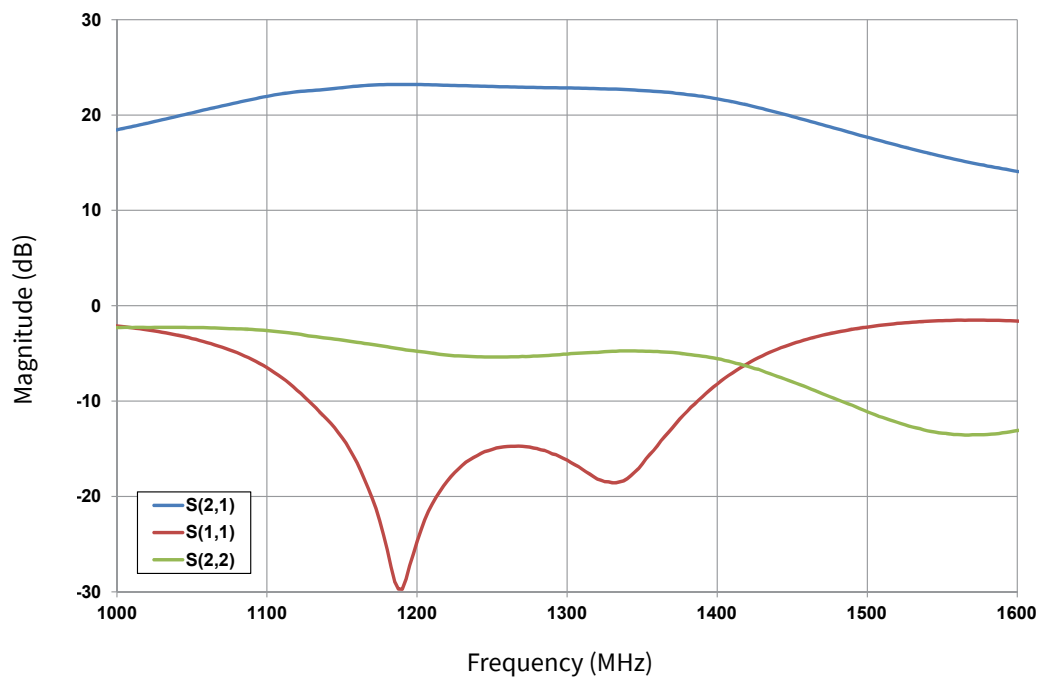


Figure 1. CGHV14250 Typical S Parameters

$T_C = 25^\circ\text{C}$, $V_{DD} = 50\text{ V}$, $I_{DQ} = 500\text{ mA}$

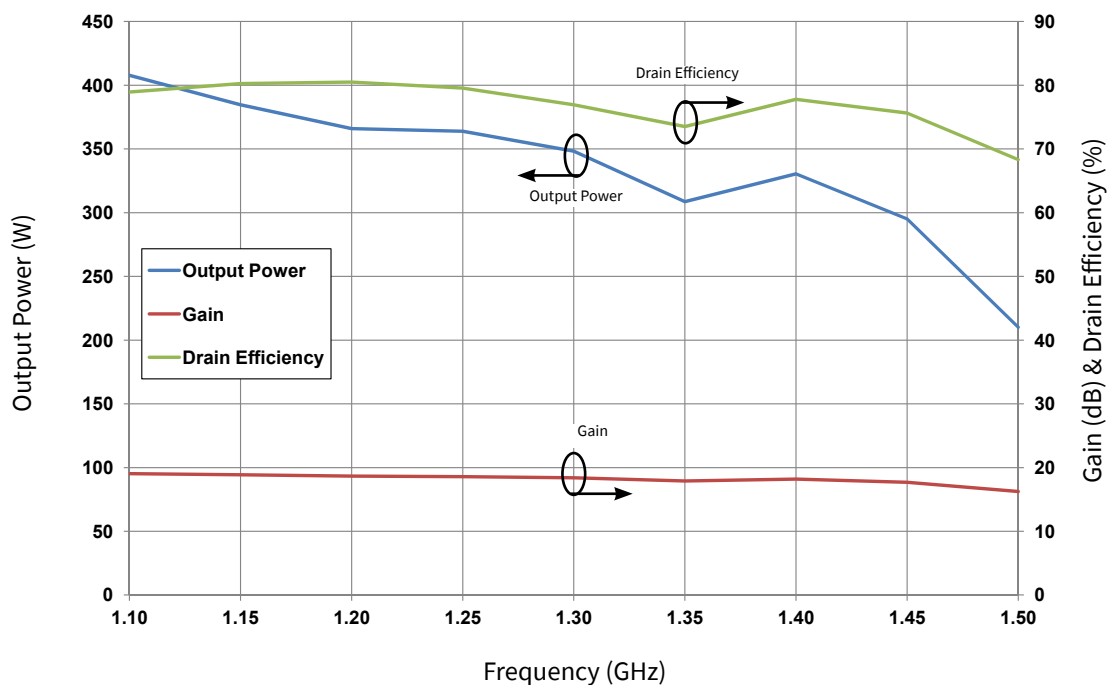


Figure 2. CGHV14250 Typical RF Results

$V_{DD} = 50\text{ V}$, $I_{DQ} = 500\text{ mA}$, $P_{IN} = 37\text{ dBm}$
 $T_C = 25^\circ\text{C}$, Pulse Width = 500 μs , Duty Cycle = 10%

Typical Performance

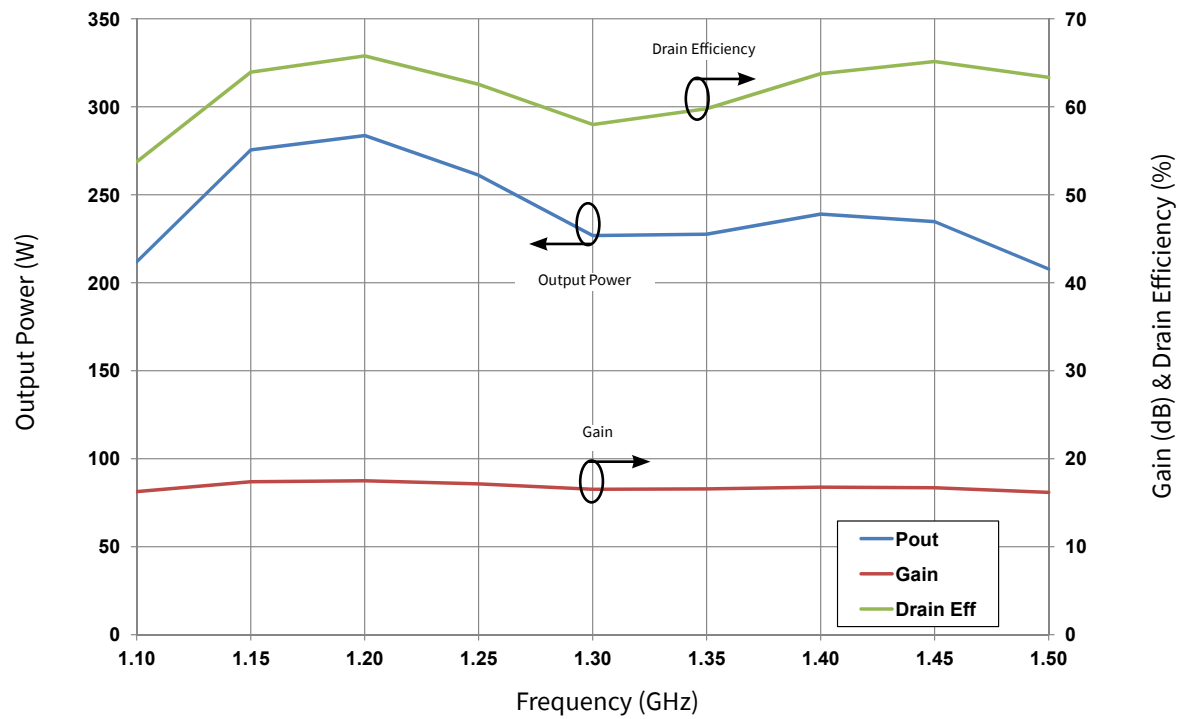
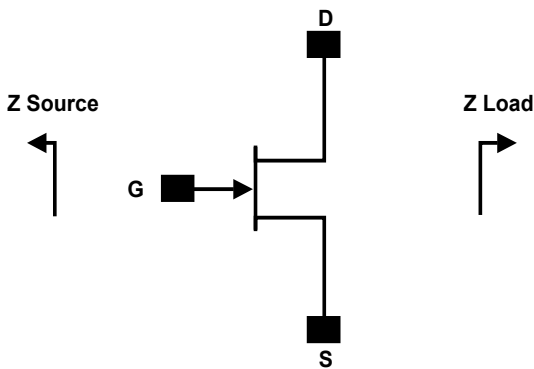


Figure 3. CGHV14250 CW RF Results
 $V_{DD} = 50\text{ V}$, $I_{DQ} = 500\text{ mA}$, $P_{IN} = 37\text{ dBm}$, $T_C = 65^\circ\text{C}$



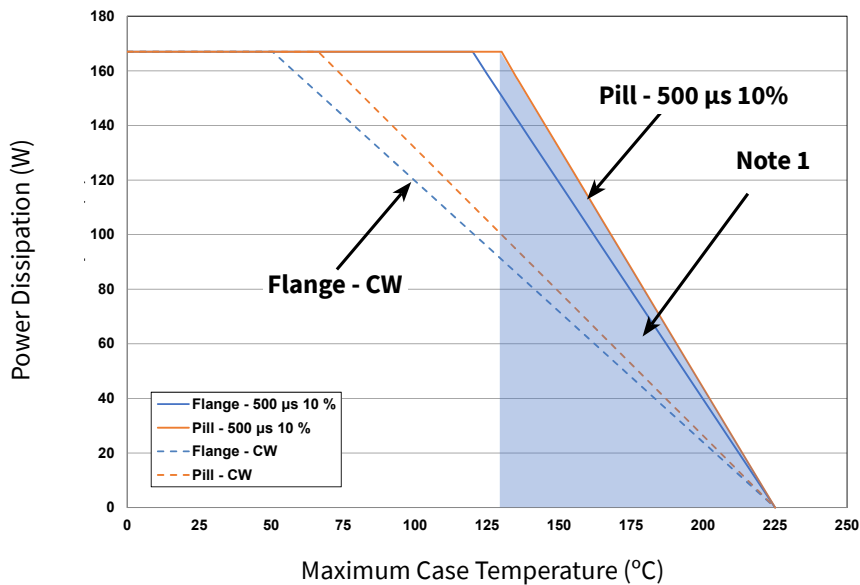
Source and Load Impedances



Frequency	Z Source	Z Load
900	0.6 - j0.3	5.3 + j0.1
1000	0.7 - j0.8	4.3 + j0.8
1100	1.3 - j1.1	3.3 + j0.8
1200	1.8 - j1.1	3.0 + j0.4
1300	2.5 - j0.7	2.5 + j0.4
1400	3.4 - j0.7	2.3 + j0.1
1500	1.8 - j0.9	2.3 + j0

- Notes:
- ¹ $V_{DD} = 50\text{ V}$, $I_{PO} = 500\text{ mA}$ in the 440162 package
 - ² Optimized for power gain, P_{SAT} and Drain Efficiency
 - ³ When using this device at low frequency, series resistors should be used to maintain amplifier stability

CGHV14250F Power Dissipation De-rating Curve



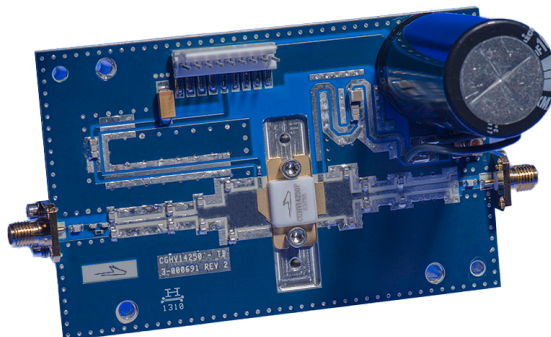
- Note:
- ¹ Area exceeds Maximum Case Operating Temperature (See Page 2)



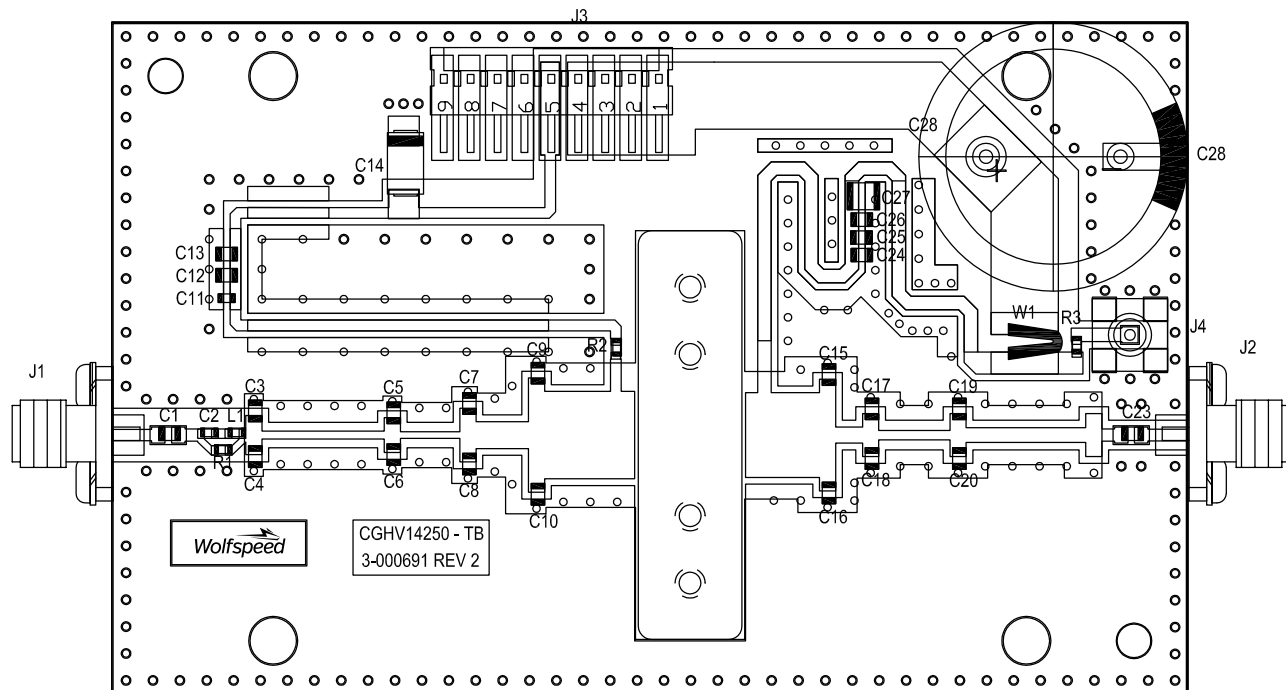
CGHV14250-AMP Demonstration Amplifier Circuit Bill of Materials

Designator	Description	Qty
R1	RES, 1/16W, 0603, 1%, 562 ohms	1
R2	RES, 5.1 ohms, +/-1%, 1/16W, 0603	1
R3	RES, 1/16W, 0603, 1%, 4700 ohms	1
L1	INDUCTOR, CHIP, 6.8 nH, 0603 SMT	1
C1, C23	CAP, 27pF, +/- 5%, 250V, 0805, ATC 600F	2
C2	CAP, 2.0pF, +/- 0.1pF, 0603, ATC	1
C3, C4	CAP, 0.5pF, +/-0.05pF, 0805, ATC 600F	2
C5,C6	CAP, 1.0pF, +/-0.05 pF, 0805, ATC 600F	2
C7,C8,C9,C10	CAP, 3.0pF, +/-0.1pF, 250V, 0805, ATC 600F	4
C11,C24	CAP, 47pF,+/-5%, 250V, 0805, ATC 600F	2
C12,C25	CAP, 100pF, +/-5%, 250V, 0805, ATC 600F	2
C13,C26	CAP, 33000pF, 0805, 100V, X7R	2
C14	CAP, 10μF, 16V, TANTALUM	1
C15,C16,C17,C18	CAP, 3.9pF, +/-0.1pF, 250V, 0805, ATC 600F	4
C19,C20	CAP, 1.2pF, +/-0.05pF, 0805, ATC 600F	2
C27	CAP, 1.0μF, 100V, 10%, X7R, 1210	1
C28	CAP, 3300 μF, +/-20%, 100V, ELECTROLYTIC	1
J1,J2	CONN, SMA, PANEL MOUNT JACK, FL	2
J3	HEADER RT>PLZ .1CEN LK 9POS	1
J4	CONNECTOR ; SMB, Straight, JACK, SMD	1
W1	CABLE, 18 AWG, 4.2	1
-	PCB, RO4350, 0.020 MIL THK, CGHV14250, 1.2-1.4GHZ	1
Q1	CGHV14250	1

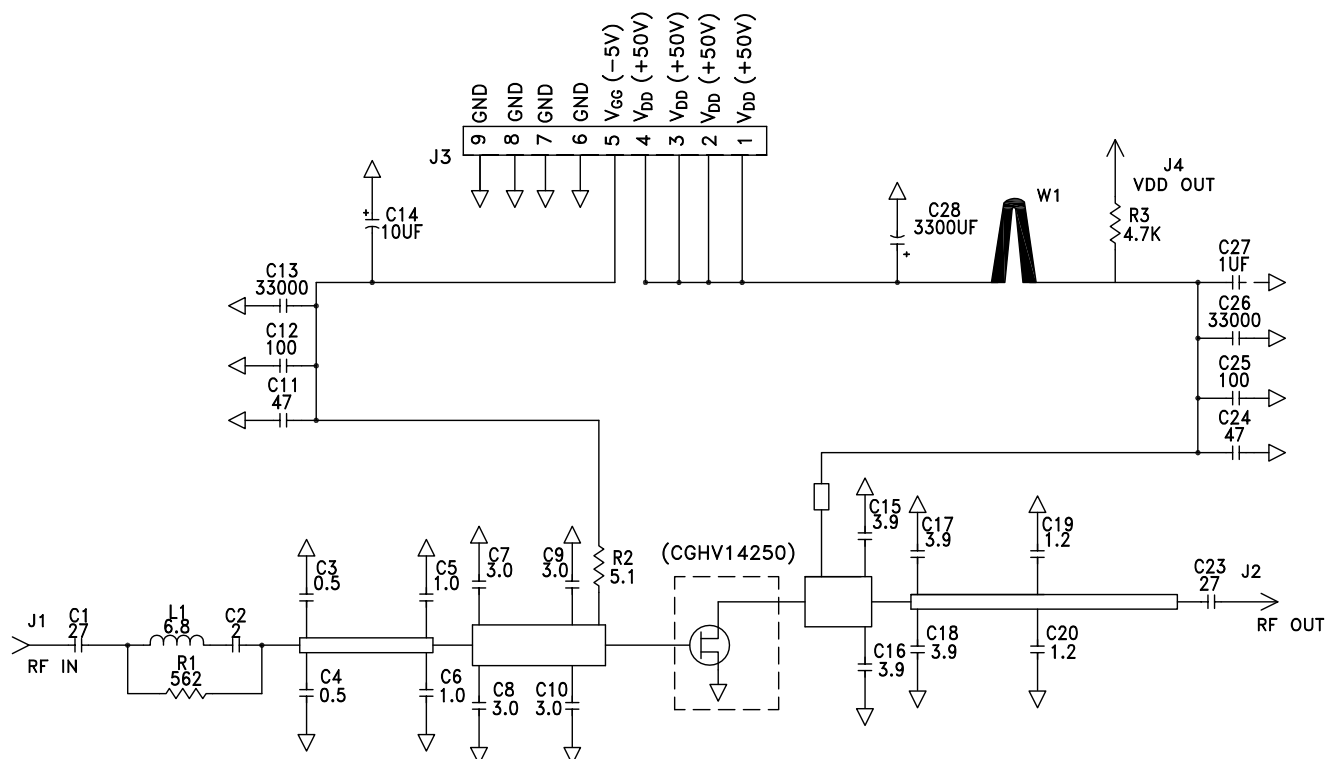
CGHV14250-AMP Demonstration Amplifier Circuit



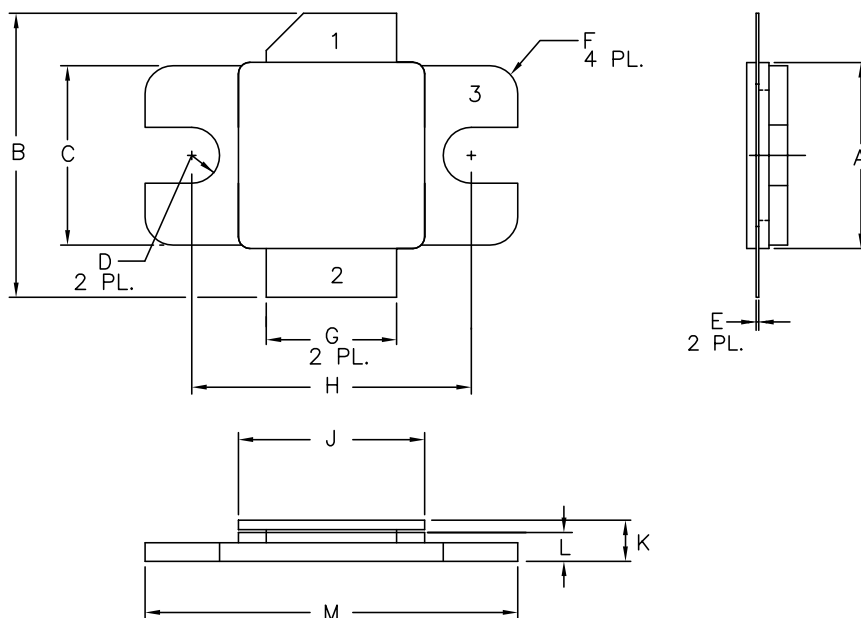
CGHV14250-AMP Demonstration Amplifier Circuit Outline



CGHV14250-AMP Demonstration Amplifier Circuit Schematic



Product Dimensions CGHV14250F (Package Type — 440162)



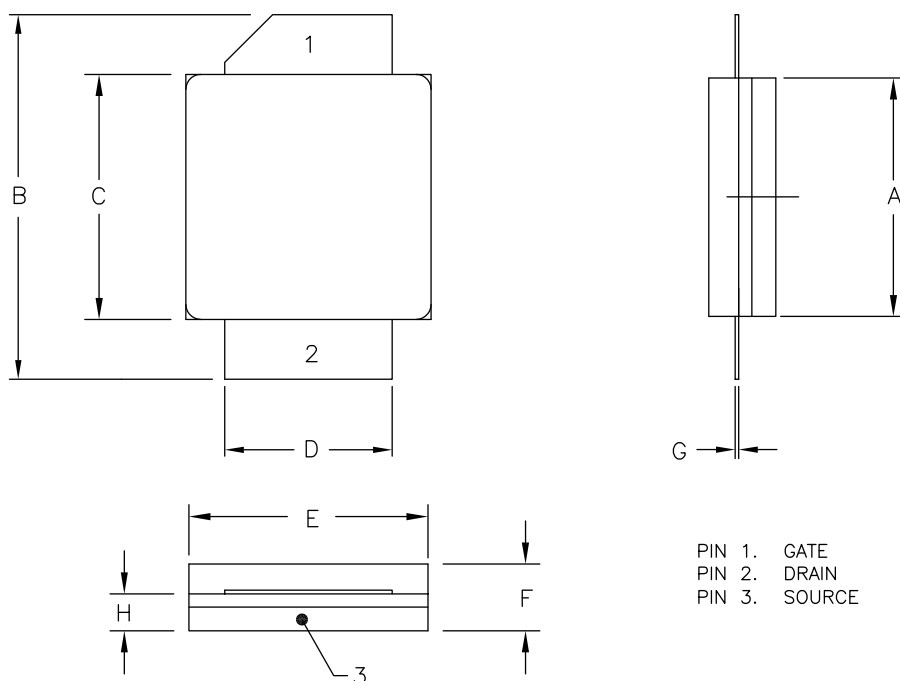
NOTES:

1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: INCH.
3. ADHESIVE FROM LID MAY EXTEND A MAXIMUM OF 0.020" BEYOND EDGE OF LID.
4. LID MAY BE MISALIGNED TO THE BODY OF THE PACKAGE BY A MAXIMUM OF 0.008" IN ANY DIRECTION.

DIM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	.395	.405	10.03	10.29
B	.580	.620	14.73	15.75
C	.380	.390	9.65	9.91
D	.055	.065	1.40	1.65
E	.004	.006	0.10	0.15
F	.055	.065	1.40	1.65
G	.275	.285	6.99	7.24
H	.595	.605	15.11	15.37
J	.395	.405	10.03	10.29
K	.129	.149	3.28	3.78
L	.053	.067	1.35	1.70
M	.795	.805	20.19	20.45

PIN 1. GATE
PIN 2. DRAIN
PIN 3. SOURCE

Product Dimensions CGHV14250P (Package Type — 440161)



NOTES:

1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: INCH.
3. ADHESIVE FROM LID MAY EXTEND A MAXIMUM OF 0.020" BEYOND EDGE OF LID.
4. LID MAY BE MISALIGNED TO THE BODY OF PACKAGE BY A MAXIMUM OF 0.008" IN ANY DIRECTION.

DIM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	.395	.407	10.03	10.34
B	.594	.634	15.09	16.10
C	.395	.407	10.03	10.34
D	.275	.285	6.99	7.24
E	.395	.407	10.03	10.34
F	.129	.149	3.28	3.78
G	.004	.006	0.10	0.15
H	.057	.067	1.45	1.70

PIN 1. GATE
PIN 2. DRAIN
PIN 3. SOURCE



Part Number System

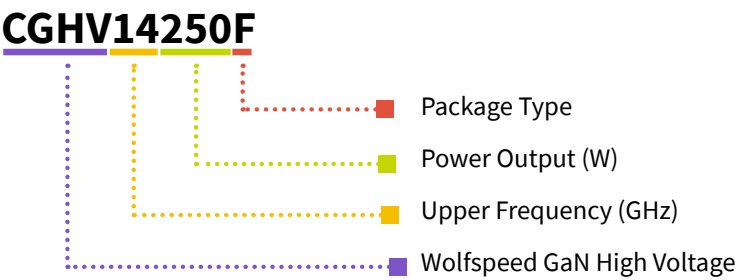


Table 1.

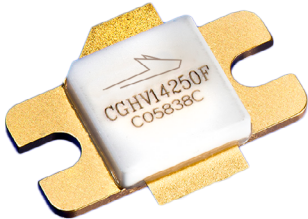
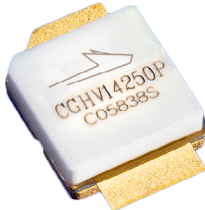
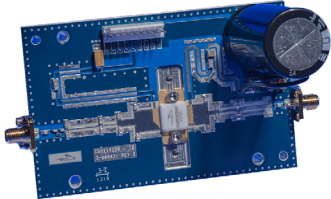
Parameter	Value	Units
Upper Frequency ¹	1.4	GHz
Power Output	250	W
Type	F = Flanged P = Package	—

Note:
¹ Alpha characters used in frequency code indicate a value greater than 9.9 GHz. See Table 2 for value.

Table 2.

Character Code	Code Value
A	0
B	1
C	2
D	3
E	4
F	5
G	6
H	7
J	8
K	9
Examples:	1A = 10.0 GHz 2H = 27.0 GHz

Product Ordering Information

Order Number	Description	Unit of Measure	Image
CGHV14250F	GaN HEMT	Each	
CGHV14250P	GaN HEMT	Each	
CGHV14250F-AMP	Test board with GaN HEMT installed, 1.2 - 1.4 GHz	Each	

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RF Product Marketing Contact
RFMarketing@wolfspeed.com

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